IPC ASSOCIATION ELECTRONICS	© Copyright 2005	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both This d	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfc Information				
upplier	Information								,						
Company name* Compan				mpany unique ID			Unique ID Authority					Response Date*			
nsemi											2023-06-08				
Contact Na	me		Title - Contact			Phor	Phone - Contact*				Email - Contact*				
Product-E	nv-Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized	Representative*		Title - Representative			Phor	Phone - Representative*			Email - Representative*					
Product-E	nv-Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Item	Number	Mfr Item Name		Effe	ective Date	e Version Manufacturing Site		V	Veight*	UOM	Unit Type		
		NCP161BFCT500T2G CSP LDO 450m		CSP LDO 450mA,	Non-Active Dischar	ge 202	2023-06-08 CNQ		CNQ	0	.313731	mg	Each		
	turing Process Inform								·				·		
	2 7			Terminal Base Alloy J-STD-020 MSL Rate		g									
1	Matte Tin (Sn) - annealed	0	CU Alloy	1			260		C	30	second	ls 3			
omments															
<u>vel 1 - ma</u>	ximum time at peak tempera	ature during sol	ldering is 10-3	0 seconds											
or more in	nformation regarding materi	al composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Bump	0.0438	mg	Supplier	Tin (Sn)	7440-31-5		0.0108	mg
			Supplier	Copper (Cu)	7440-50-8		0.033	mg
Die	0.24779	mg	Supplier	Silicon (Si)	7440-21-3		0.2464	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0014	mg
Protection coat	0.00637	mg		Polyimide	proprietary data		0.0064	mg
Under Bump Metal	0.015771	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0155	mg